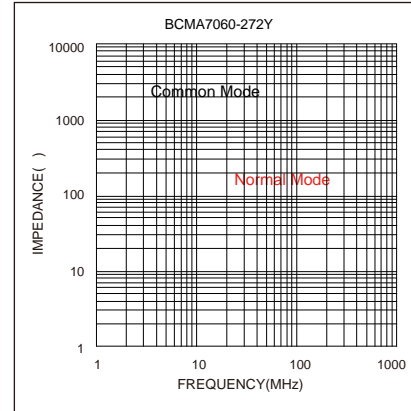
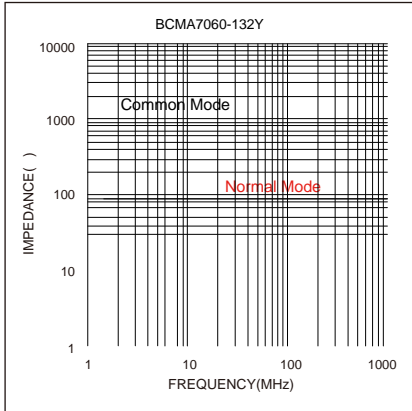
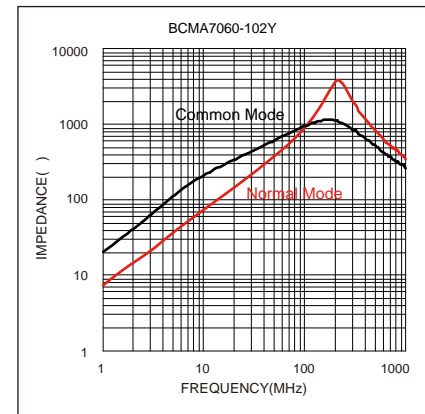
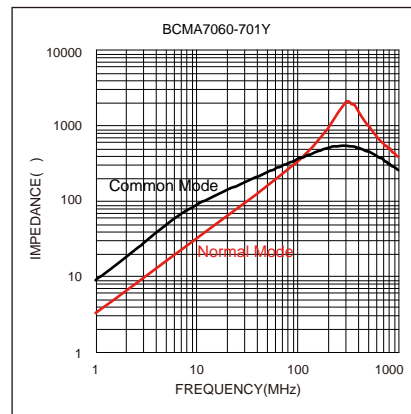
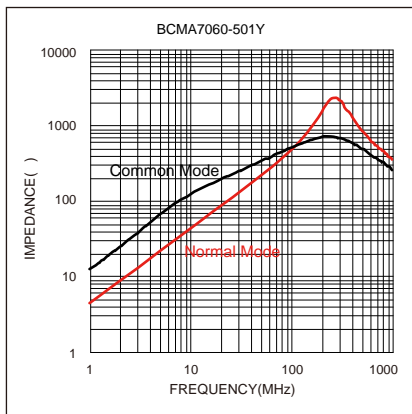
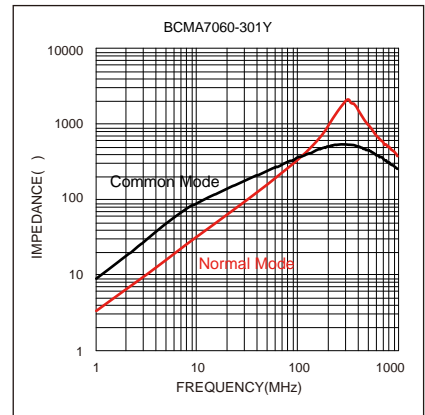
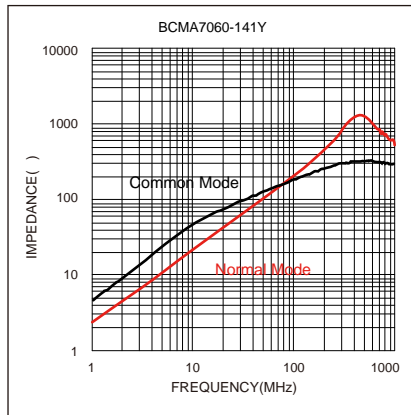
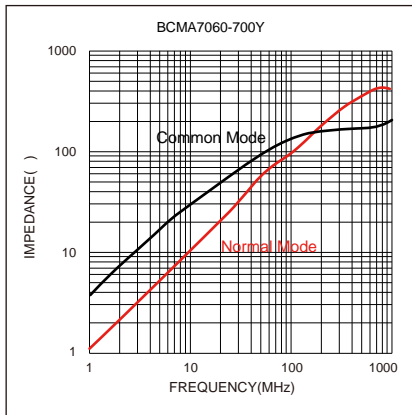
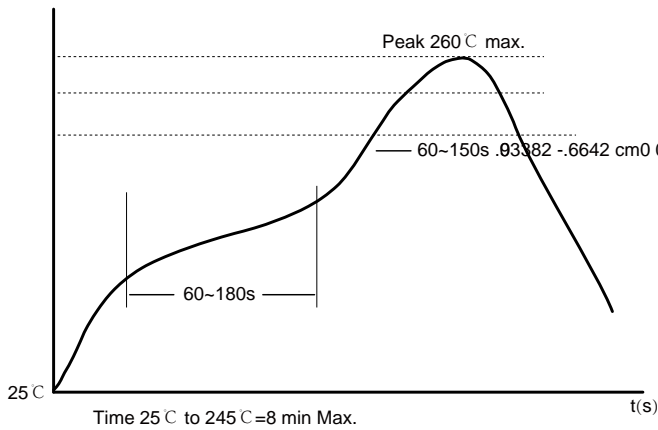




# Typical Electrical Characteristics:



## Soldering Reflow:



Preheat condition: 150 ~200 °C / 60~180 sec.

Allowed time above 217 °C: 60~150 sec.

Max temperature: 260 °C.

Max time at max temperature: 10 sec.

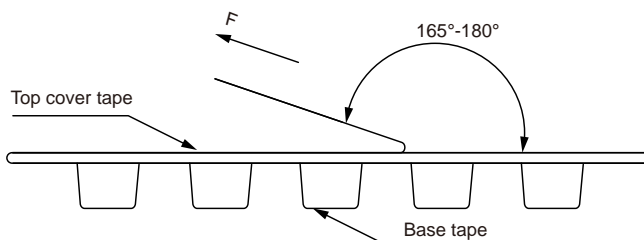
Allowed Reflow time: 3x max.

## Packaging Information:

### Tape Dimension :

Series	A0 (mm)	B0 (mm)	D (mm)	P0 (mm)	P1 (mm)	W (mm)	K0 (mm)	E (mm)	T (mm)
BCMA7060	6.25± 0.1	7.7± 0.1	1.5± 0.1	4.0± 0.1	12.0± 0.1	16.0± 0.3	3.6± 0.1	1.75± 0.1	0.40± 0.05

### Peel force of top cover tape:

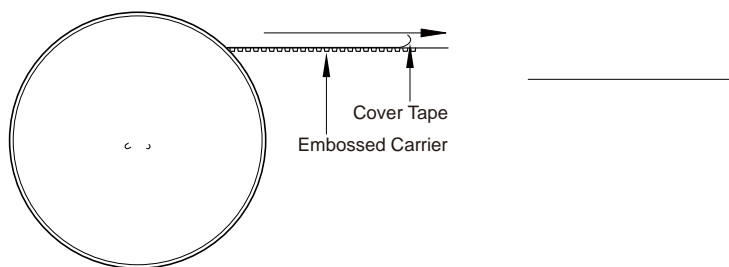


The peel force of top cover tape shall be between 0.10 to 1.17 N

### Product Marking:

Marking	Printing Impedance)
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Reel Dimension: [mm]



Packaging Quantity: